# **MOSFET** – Power, N-Channel, SUPERFET<sup>®</sup> III, Easy Drive

# 650 V, 24 A, 125 m $\Omega$

# FCPF125N65S3

#### Description

SUPERFET III MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provides superior switching performance, and withstand extreme dv/dt rate.

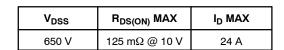
Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

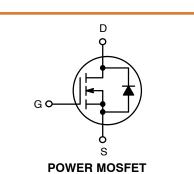
#### Features

- 700 V @  $T_J = 150^{\circ}C$
- Typ.  $R_{DS(on)} = 105 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 44 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 405 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

#### Applications

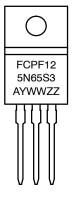
- Computing / Display Power Supplies
- Telecom / Server Power Supplies
- Industrial Power Supplies
- Lighting / Charger / Adapter







#### MARKING DIAGRAM



FCPF125N65S3 A

YWW

ZZ

= Specific Device Code

- = Assembly Location
- = Date Code (Year & Week)
- = Assembly Lot

## **ORDERING INFORMATION**

Device	Package	Shipping
FCPF125N65S3	TO-220 Fullpack	1000 Units / Tube

Symbol	Parameter	Value	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		650	V
V <sub>GSS</sub>	Gate to Source Voltage	– DC	±30	V
		– AC (f > 1 Hz)	±30	
Ι <sub>D</sub>	Drain Current	– Continuous (T <sub>C</sub> = 25°C)	24*	Α
		– Continuous (T <sub>C</sub> = 100°C)	15*	
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	60*	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		115	mJ
I <sub>AS</sub>	Avalanche Current (Note 2)		3.7	A
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		0.38	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)	38	W
		- Derate Above 25°C	0.31	W/°C
TJ, T <sub>STG</sub>	Operating and Storage Temperature Range		–55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. \*Drain current limited by maximum junction temperature.

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 3.7 \text{ A}, R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}\text{C}$ . 3.  $I_{SD} \le 12 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{ V}_{DD} \le 400 \text{ V}, \text{ starting } T_J = 25^{\circ}\text{C}$ .

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	3.24	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

# **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS	-			•	
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650			V
		$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 150°C	700			V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to 25°C		0.65		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 650 V, V <sub>GS</sub> = 0 V			1	μΑ
		$V_{DS} = 520 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		1.35		
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 30$ V, $V_{DS} = 0$ V			±100	nA
ON CHARACTE	ERISTICS	-				
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 0.54 \text{ mA}$	2.5		4.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12 A		105	125	mΩ
9fs	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 12 A		16		S
YNAMIC CHA	RACTERISTICS	-			•	•
Ciss	Input Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz		1790		pF
Coss	Output Capacitance			40		pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$		405		pF
Coss(er.)	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		60		pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DS}$ = 400 V, I <sub>D</sub> = 12 A, V <sub>GS</sub> = 10 V (Note 4)		44		nC
Q <sub>gs</sub>	Gate to Source Gate Charge			12		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			19		nC
ESR	Equivalent Series Resistance	f = 1 MHz		4		Ω
WITCHING CH	IARACTERISTICS	-				
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 12 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$		22		ns
t <sub>r</sub>	Turn-On Rise Time	R <sub>g</sub> = 4.7 Ω (Note 4)		25		ns
t <sub>d(off)</sub>	Turn-Off Delay Time			60		ns
t <sub>f</sub>	Turn-Off Fall Time	1		15		ns
OURCE-DRAI	N DIODE CHARACTERISTICS			•	•	•
۱ <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current				24	Α
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current		1		60	А
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{SD} = 12 A$	1		1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>DD</sub> = 400 V, I <sub>SD</sub> = 12 A,	1	362		ns
Qrr	Reverse Recovery Charge	dI <sub>F</sub> /dt = 100 A/µs		6.36	1	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6.36

μC

4. Essentially independent of operating temperature typical characteristics.

Reverse Recovery Charge

Qrr

#### **TYPICAL PERFORMANCE CHARACTERISTICS**

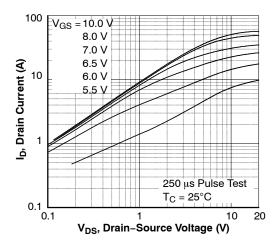
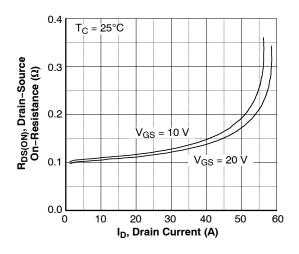
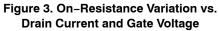


Figure 1. On–Region Characteristics





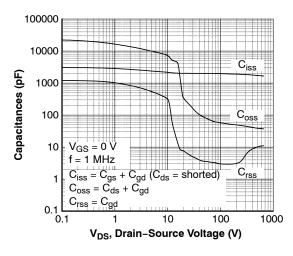


Figure 5. Capacitance Characteristics

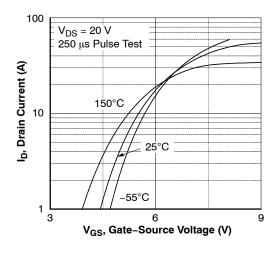
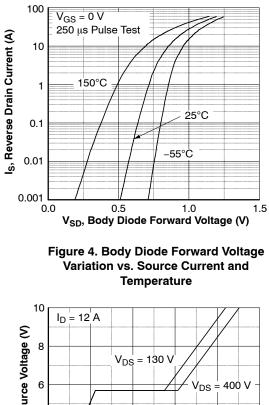


Figure 2. Transfer Characteristics



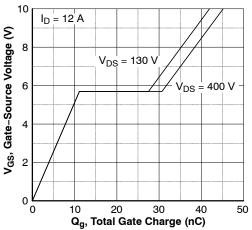
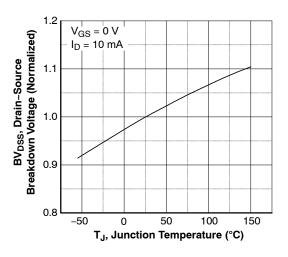
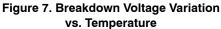


Figure 6. Gate Charge Characteristics

#### TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)





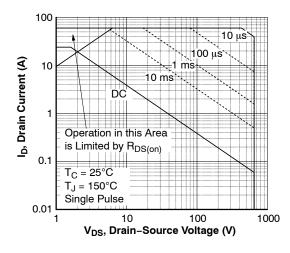


Figure 9. Maximum Safe Operating Area

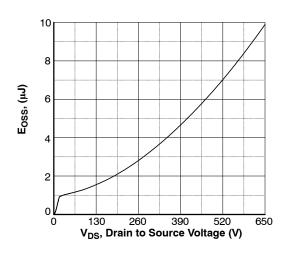


Figure 11. E<sub>OSS</sub> vs. Drain to Source Voltage

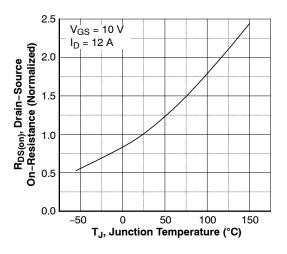


Figure 8. On–Resistance Variation vs. Temperature

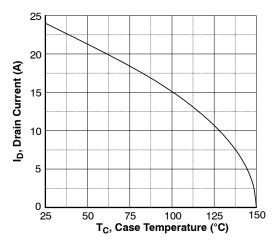


Figure 10. Maximum Drain Current vs. Case Temperature

# TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

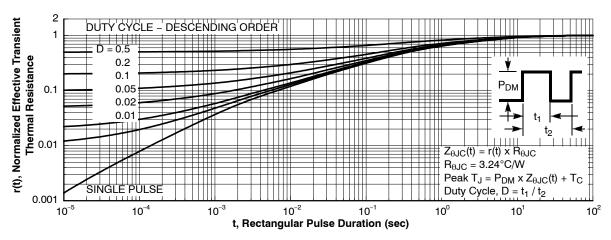
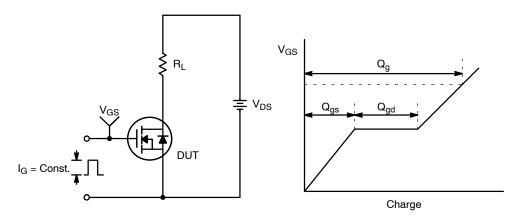


Figure 12. Transient Thermal Response Curve





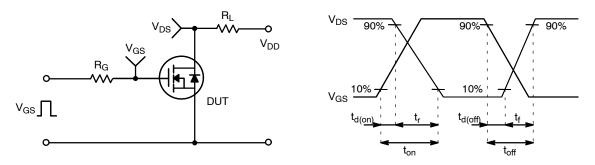
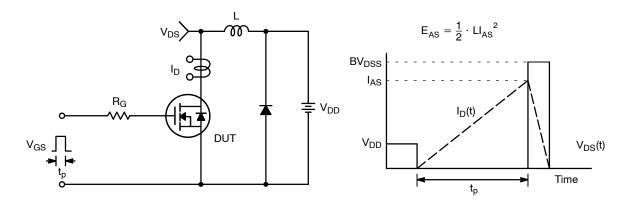


Figure 14. Resistive Switching Test Circuit & Waveforms





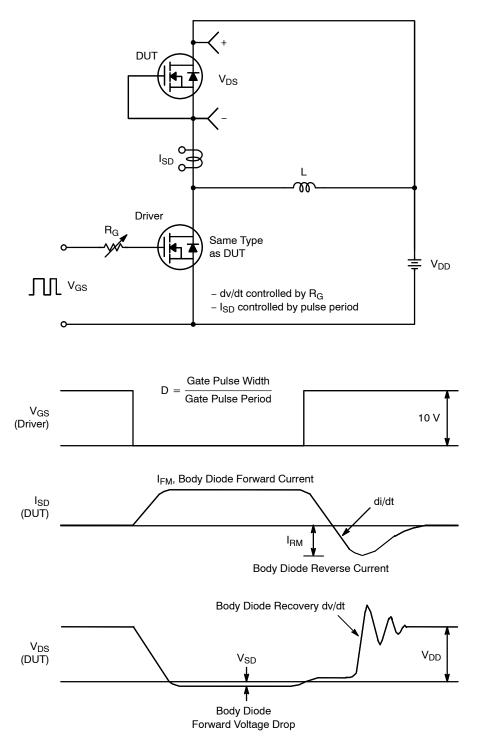
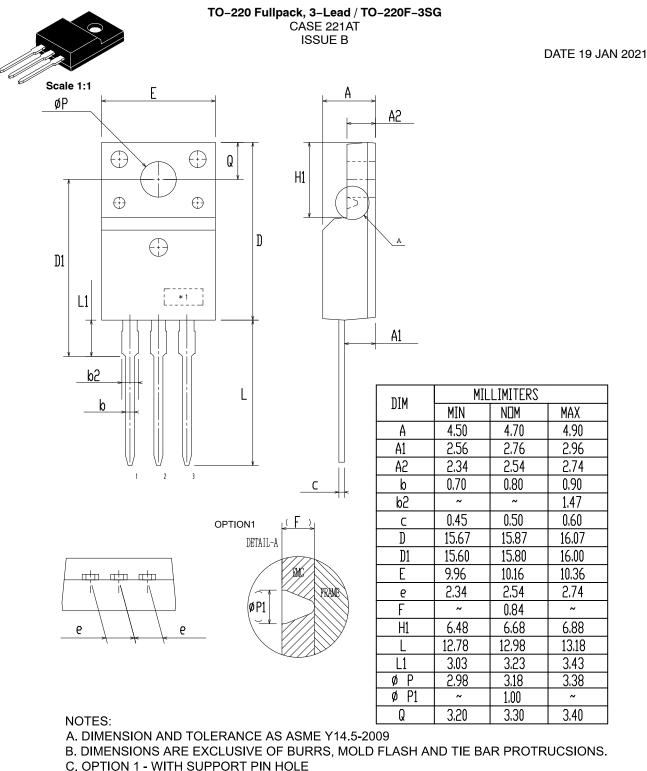


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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# onsemi



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